

Title (en)
INTERCONNECTION SYSTEM

Title (de)
VERBUNDUNGSSYSTEM

Title (fr)
SYSTEME D'INTERCONNEXION

Publication
EP 1543588 A4 20070411 (EN)

Application
EP 03765915 A 20030723

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- US 0322896 W 20030723
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Abstract (en)
[origin: WO2004010749A2] An interconnection system includes spacers arranged adjacent each other in a row, the spacers having printed circuit boards disposed therebetween. Each printed circuit board has at least one pair of electrical conductors respectively disposed on opposite faces thereof. All of the printed circuit boards have one end exposed on a first plane and a second end exposed on a second plane. Electrically conductive contacts are disposed within cells in a pair of interposers so as to have one end making electrical contact with one of the printed circuit boards and another end extending through its respective cell in its respective interposer.

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Citation (search report)

- No further relevant documents disclosed
- See references of WO 2004010749A2

Cited by
DE4031935A1

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AT BE BG CH CY CZ DE DK EE ES FI FR GB GR HU IE IT LI LU MC NL PT RO SE SI SK TR

DOCDB simple family (publication)
WO 2004010749 A2 20040129; WO 2004010749 A3 20040701; AU 2003263799 A1 20040209; AU 2003263799 A8 20040209; CA 2493805 A1 20040129; EP 1543588 A2 20050622; EP 1543588 A4 20070411; JP 2005534177 A 20051110; JP 4387943 B2 20091224; KR 101011741 B1 20110207; KR 20050042468 A 20050509; TW 200405512 A 20040401; TW I276204 B 20070311

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